**AMENDMENTS TO THE CLAIMS:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

**LISTING OF CLAIMS:**

1. (Currently Amended) ~~Adhesive~~ An adhesive composition comprising a polyisocyanate component and a polyol component,

wherein the polyol component includes polyester polyamide polyol and/or polyurethane polyester polyamide polyol ~~including an amide bond produced by reaction between a dimer acid and polyamine~~,

the polyester polyamide polyol comprises a polyester unit formed by reaction between polybasic acid and/or alkylester thereof and polyol, and a polyamide unit which comprises an amide bond formed by reaction between dimer acid and polyamine as an essential component and is formed by reaction between polybasic acid and polyamine,

the polyurethane polyester polyamide polyol is formed by reaction between the polyester polyamide polyol and polyisocyanate, and

~~wherein~~ concentration of a cyclic compound containing the amide bond and/or an ester bond in extracted water which is extracted from a composite film adhesively bonded by the adhesive composition by water of 0.5mL/cm$^2$ per unit area of the composite film is 0.5ppb or less in terms of dibutyl phthalate concentration measured with a gas chromatograph-flame ionization detector.

2. (Currently Amended) The adhesive composition according to Claim 1, wherein ~~the polyester polyamide polyol and/or the polyurethane polyester polyamide polyol includes the ester bond produced by reaction between a polybasic acid and/or alkylester thereof and polyol, and wherein~~ the polybasic acid of the polyester unit is an aromatic dibasic acid and/or the dimer acid.

3. (Original) The adhesive composition according to Claim 1, wherein 10-90mol% of a carboxyl group of the dimer acid forming the amide bond reacts with an amino group of the polyamine.

4. (Original) The adhesive composition according to Claim 1, which further comprises a silane coupling agent.

5. (Canceled)

6. (Currently Amended) A flexible packaging composite film adhesively bonded by adhesive composition ~~which comprises~~ comprising a polyisocyanate component and a polyol component,

wherein the polyol component ~~including~~ includes polyester polyamide polyol and/or polyurethane polyester polyamide polyol ~~including an amide bond produced by reaction between a dimer acid and polyamine~~

the polyester polyamide polyol comprises a polyester unit formed by reaction between polybasic acid and/or alkylester thereof and polyol and a polyamide unit which comprises an amide bond formed by reaction between dimer acid and

polyamine as an essential component and is formed by reaction between polybasic acid and polyamine,

the polyurethane polyester polyamide polyol is formed by reaction between the polyester polyamide polyol and polyisocyanate, and

~~in which~~ concentration of a cyclic compound containing the amide bond and/or an ester bond in extracted water which is extracted from the composite film adhesively bonded by the adhesive composition by water of 0.5mL/cm$^2$ per unit area of the composite film is 0.5ppb or less in terms of dibutyl phthalate concentration measured with a gas chromatograph-flame ionization detector.

7. (New) The adhesive composition according to Claim 1, wherein the polybasic acid of the polyester unit is at least one kind selected from the group consisting of phthalic acid, naphthalenedicarboxylic acid and dimer acid.

8. (New) The adhesive composition according to Claim 1, wherein the polyester unit comprises an ester bond formed by reaction between phthalic acid and/or alkyl ester thereof and glycol comprising no ether linkage in a principal chain and having 6-7 carbons in the principal chain an ester bond formed by reaction between naphthalene dicarboxylic acid and/or alkyl ester thereof and glycol, and an ester bond formed by reaction between dimer acid and glycol as principal ester bonds.

9. (New) The adhesive composition according to Claim 1, wherein the polyamide unit comprises an amide bond formed by reaction between dimer acid and aliphatic diamine and/or an amide bond formed by reaction between dimer acid and alicyclic diamine as a principal amide bond.